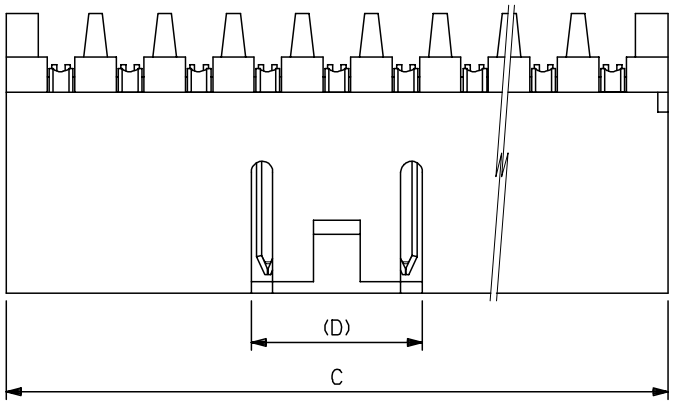
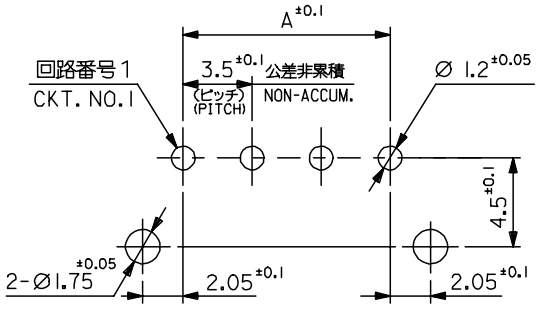
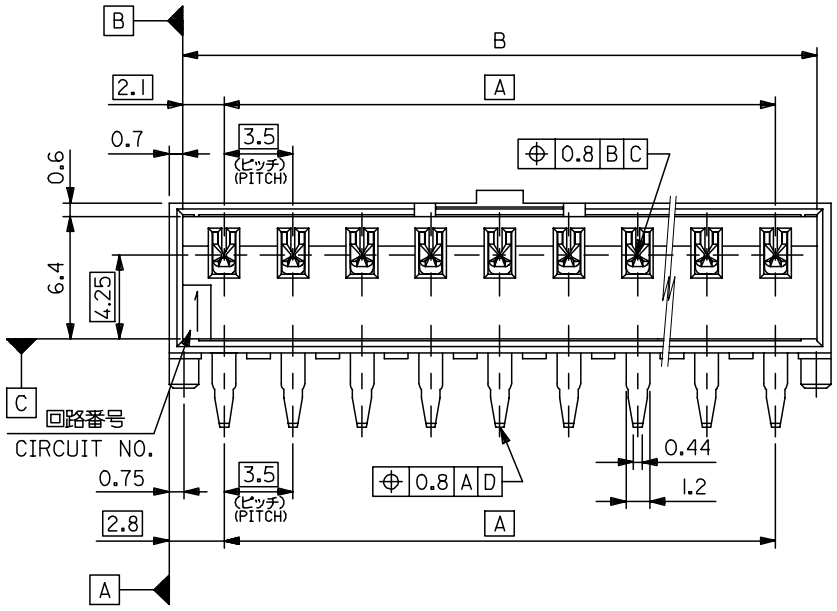


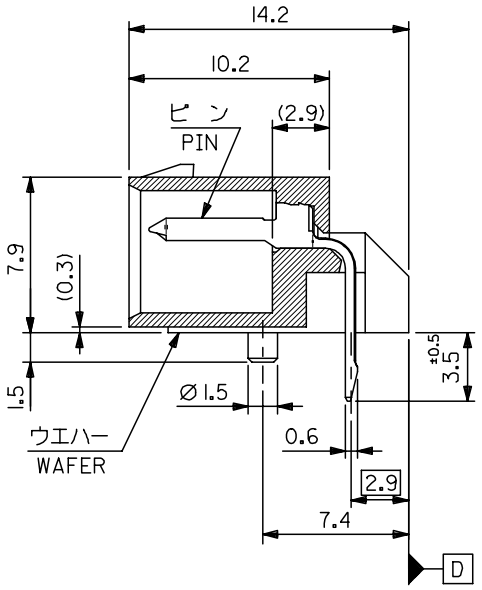


基板取付穴推奨寸法（参考）（t＝1．6）
RECOMMENDED P.C. BOARD HOLE DIM. (REF.)

注記 NOTES

1. 嵌合相手：51067 シリーズ
   MATE WITH : 51067 SERIES
2. 材質
   MATERIAL
   ウエハー：PBTP（ガラス15%入り）、UL94V-0
   WAFER : PBTP (G.F 15%), UL94V-0
   ピン　：リン青銅、ニッケル下地　錫メッキ (t=0.254)
   PIN　: PHOSPHOR BRONZE
   TIN OVER NICKEL PLATING (t=0.254)
3. 本製品は　53259-＊＊10　の鉛フリー品である。
   THIS PRODUCT IS LEAD FREE OF 53259-**10.





8.7	54.6	53.2	49.0	53259-1517	15
	51.1	49.7	45.5	-1417	14
	47.6	46.2	42.0	-1317	13
	44.1	42.7	38.5	-1217	12
	40.6	39.2	35.0	-1117	11
	37.1	35.7	31.5	-1017	10
	33.6	32.2	28.0	-0917	9
	30.1	28.7	24.5	-0817	8
	26.6	25.2	21.0	-0717	7
	23.1	21.7	17.5	-0617	6
	19.6	18.2	14.0	-0517	5
8.7	16.1	14.7	10.5	-0417	4
6.1	12.6	11.2	7.0	-0317	3
6.1	9.1	7.7	3.5	53259-0217	2
(D)	C	B	A	MATERIAL NO.	CKT. 極数

MODEL NO. 53259-**17

REVISED
EC NO: J2008-1469 2007/10/22
DRWN:MHAYASHI 2007/10/23
CHKD:THARUYAMA 2007/10/24
APPR:NUKITA
DESCRIPTION
REV B

GENERAL TOLERANCES (UNLESS SPECIFIED)

10 UNDER	±0.2
10 OVER 30 UNDER	±0.25
30 OVER	±0.3
ANGULAR	±3 °

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE	SCALE	DESIGN UNITS	
MM ONLY	---	METRIC	THIRD ANGLE PROJECTION

DRAWN BY / DATE	T.UENO 2004/04/22
CHECKED BY / DATE	M.SASAO 2004/04/22
APPROVED BY / DATE	M.SASAO 2004/04/22
MATERIAL NO.	SEE CHART

TITLE
3.5 W/B CONN
WAFER ASSY R/A
-LEAD FREE-

molex MOLEX INCORPORATED

DOCUMENT NO. SD-53259-002
SHEET NO. 1 OF 1

SIZE A3

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